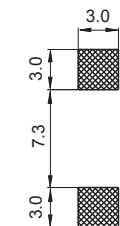
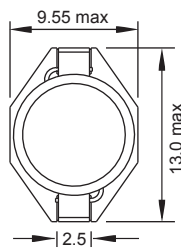
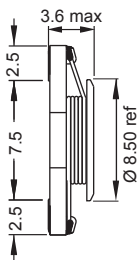
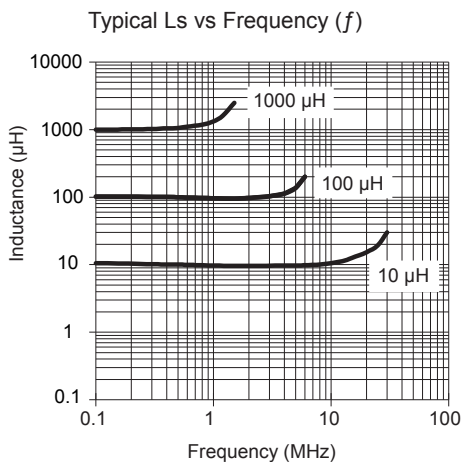


PISL



Recommended Layout
for solder pads



Part No	Inductance	f _L	Tol	SRF	DCR	Rated DC Current (A)	
	L (µH)	(MHz)	± (%)	min (MHz)	max (Ω)	I _{sat}	I _{ΔT} = 40°C
PISL-150X-04	15	0.1	20	24	0.07	2.10	1.7
PISL-220X-04	22	0.1	10, 20	19	0.10	1.70	1.4
PISL-330X-04	33	0.1	10, 20	15	0.16	1.40	1.2
PISL-470X-04	47	0.1	10, 20	12	0.22	1.10	0.9
PISL-680X-04	68	0.1	10, 20	10	0.33	0.90	0.8
PISL-101X-04	100	0.1	10, 20	8.0	0.46	0.75	0.7
PISL-151X-04	150	0.1	10, 20	5.5	0.69	0.60	0.55
PISL-221X-04	220	0.1	10, 20	4.9	1.0	0.50	0.45
PISL-331X-04	330	0.1	10, 20	3.5	1.5	0.40	0.35
PISL-471X-04	470	0.1	10, 20	3.0	2.0	0.35	0.30
PISL-681X-04	680	0.1	10, 20	2.3	2.8	0.25	0.25
PISL-102X-04	1000	0.1	10, 20	1.8	3.9	0.20	0.10
PISL-222X-04	2200	0.1	10, 20	1.8	10.0	0.12	0.10
PISL-682X-04	6800	0.1	10, 20	1.5	30.0	0.05	0.045

Revision date : 06 Feb 2013

Material : Ferrite, Plastic moulded base
Terminal clip with lead-free tinned surface for SMT-Reflow soldering.

SPQ : Reel 1500 [-04]

Remarks : I_{sat} & I_{ΔT} - see description in Inductors Technical Data.

SMD Power Inductors (also shielded)

FASTRON power inductors can withstand a wide temperature range. The inductance values range from 1.0 μH to 10000 μH and they are suitable for high rated currents. They have a high reliability and can be assembled by surface mount technology. Their low DC resistance keeps power losses to a minimum. They are also suitable for Filtering of supply voltages, Coupling, Decoupling, Automotive electronics and Network switching systems.

Applications These components are widely used in power supplies for VTR, LCD TV, notebooks, PC and DC/DC converters.

Technical Data

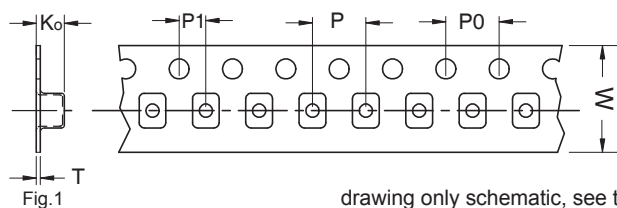
L – Value (rated inductance)	Measured with HP 4194A Impedance / Gain-phase Analyzer at frequency f_L
SRF (min) – (unshielded only)	Measured with HP 8753ES Network Analyzer
DCR (max)	Measured at 25°C
Rated DC Current	Isat max. current based on and inductivity drop of 30% (SPISG) respectively 10% (PISG, PISL, PISM, PISN, PISR & PIST) related to the unloaded inductivity I ΔT max. current based on temperature rise: determined at the point where the temperature rise does not exceed 30°C (PISG) respectively 40°C (PISL, PISM, PISN, PISR, PIST & SPISM) above the ambient temperature of 25°C I rated current indicates the current when inductivity drop of 25% max related to the unloaded inductivity or when temperature raise $\Delta T=40^\circ\text{C}$ ($T_a=20^\circ\text{C}$) whichever is lower
Operating Temperature	Non shielded: -40°C to $+150^\circ\text{C}$ (includes component self-heating) Shielded: -40°C to $+125^\circ\text{C}$ (includes component self-heating)
Recommended soldering method	Reflow
Solderability	Using lead free solder (Sn 99.9) at $260^\circ\text{C} \pm 5^\circ\text{C}$ for 5 ± 0.5 seconds, min 90% solder coverage of metallization Standard: IEC 68-2-20 (Ta)
Resistance to Soldering Heat	Resistant to $260^\circ\text{C} \pm 5^\circ\text{C}$ for 10 ± 1 seconds Standard: IEC 68-2-20 (Tb)
Resistance to Solvent	Resistant to Isopropyl alcohol for 5 ± 0.5 minutes at $23^\circ\text{C} \pm 5^\circ\text{C}$ Standard: IEC 68-2-45
Climatic Test	Defined by the following standards IEC 68-2-1 for Cold test: -55°C for 96 hours IEC 68-2-2 for Dry heat test: $+125^\circ\text{C}$ for 96 hours IEC 60068-2-78 for Humidity test: 40°C at RH 95% for 4 days
Thermal Shock Test	Temperature cycle : -40°C to $+125^\circ\text{C}$ to -40°C Max/Min temperature duration: 15 minutes Temperature transition duration: 5 minutes Cycles: 25 Standard: MIL-STD-202G
Adhesion of Soldered Component (Shear Test)	Components withstand a pushing force of 20N for 10 ± 1 seconds Standard: IEC 60068-2-21, method Ue ₃
Mechanical Shock	Mil-Std 202 Method 213 Condition C 3 axis, 6 times, total 18 shocks 100 G, 6 ms, half-sine
Vibration	Mil-Std 202 Method 204 20 mins at 5G 10 Hz to 2000 Hz 12 cycles each of 3 orientations

Ordering Code Example: PIS2408-2R9X-YY

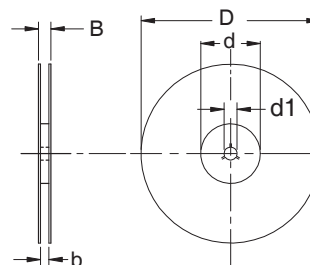
PIS 2408 - 2R9 X - YY
(Model)(Case Size) (Inductance Value)(Tolerance) (Packing Code) → **PIS2408-2R9N-04**

Case Sizes - 2408, 2416, 2812, 2816, 4716, 4720, 4728, G, L, M, N, R, T
Core Type - Ferrite
Tolerances - K (10%), M (20%), N (30%)
Packing Code - 01, 04 (Reel)

Packing Specification



drawing only schematic, see table



Type	D	d	d1	B	b	W	P	P0	P1	Ko	T
PIS 2408	330	100	13	22.4	16.4	16	12	4	2	3.0	0.35
PIS 2416	330	100	13	22.4	16.4	16	12	4	2	5.1	0.35
PIS 2812	330	100	13	22.4	16.4	16	12	4	2	3.6	0.35
PIS 2816	330	100	13	22.4	16.4	16	12	4	2	4.6	0.4
PIS 4716	330	100	13	30.4	24.4	24	16	4	2	4.8	0.30
PIS 4720	330	100	13	30.4	24.4	24	16	4	2	6.1	0.45
PIS 4728	330	100	13	30.4	24.4	24	16	4	2	8.1	0.45

Type	D	d	d1	B	b	W	P	P0	P1	Ko	T
PISG/SPISG	180	60	13	18.4	12.4	12	8	4	2	3.2	0.25
PISL	330	100	13	30.4	24.4	24	12	4	2	3.6	0.3
PISM/SPISM	330	100	13	30.4	24.4	24	12	4	2	5.4	0.3
PISN	330	100	13	30.4	24.4	24	24	4	2	11.6	0.3
PISR	330	100	13	38.4	32.4	32	24	4	2	7.6	0.3
PIST	330	100	13	38.4	32.4	32	24	4	2	12.5	0.4